



K5-WCapacitive Humidity Sensor For low humidity measurement





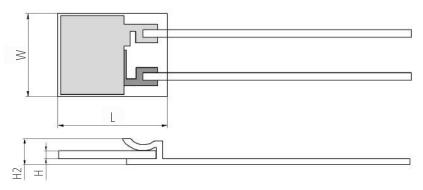




Benefits & Characteristics

- Very stable at low humidity
- High chemical resistance
- Wide temperature range
- Condensation resistant
- Very low drift
- Customer specific sensor available upon request

Illustration¹⁾



1) For actual size, see dimensions

Technical Data

| Dimensions (L x W x H / H2 in mm): | 5 x 3.81 x 0.4 / 1.2 | |
|--|---|-----------------------|
| Operating humidity range: | 0 % RH to 100 % RH | |
| Operating temperature range: | -40 °C to +150 °C | |
| Capacitance (C ₃₀):* | 200 pF ±50 pF (at 30 % RH and +23 °C) | |
| Sensitivity (at $C_{30} = 200 \text{ pF}$): | 0.4 pF/% RH (15 % RH to 90 % RH) | |
| Loss factor: | < 0.01 (at 23 °C, at 10 kHz, at 90 % RH) | |
| Linearity error: | < 1.5 % RH (15 % RH to 90 % RH at +23 °C after one point calibration) | |
| Hysteresis: | < 1.5 % RH | |
| Response time t ₆₃ : | < 5 s (50 % RH to 0 % RH at +23 °C) | |
| Temperature dependence (nominal): | Δ % RH = (B1 x % RH + B2) x T [°C] + (B3 x % RH + B4) | |
| | B1 = 0.00004 [1/°C] | B2 = 0.1842 [% RH/°C] |
| | B3 = -0.0010 | B4 = -4.2370 [% RH] |
| Measurement frequency range: | 1 kHz to 100 kHz (recommended 10 kHz) | |
| Maximal supply voltage: | $< 12 V_{pp} AC$ | |
| Signal form: | alternating signal without DC bias | |
| Connection:* | CuP-SIL wire post-plated with Sn, 10 mm | |

* Customer specific alternatives available

The calibration of the sensor must be done 5 days after soldering at the earliest.

DHK5-W_E2.2 1/5





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Order Information - SIL (CuP-SIL wire post-plated with Sn, 10 mm)



 $K5 \ (200 pF \pm 50 pF)$ Order code 040.00146









K5-WCapacitive Humidity Sensor Handling guidelines





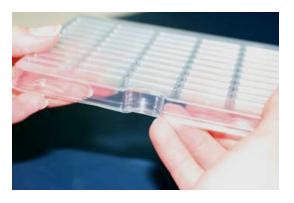
Packaging



The wired humidity sensors are packaged in blisters. Please be careful when opening the blisters to avoid any damages to the sensors.

To avoid damages please handle as follows:

1. Side with curve has to face you.



2. Push your thumb beneath cover and press carefully lock system until cover removes smoothly.



Press lock system on second side on the same way.



4. Remove cover slowly.



Storage

Sensors have to be stored only in the original blisters.

Storage environment

-20°C...+50°C /-4...122°F (temperature range of blister)







K5-WCapacitive Humidity Sensor Handling guidelines

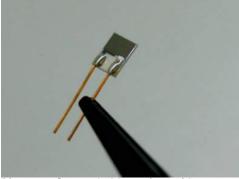




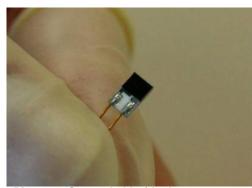


Sensor handling

Hold the sensor with plastic tweezers or with gloves on the wires only.



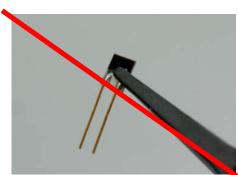
Picture 3: Sensor held on wires with plastic tweezers



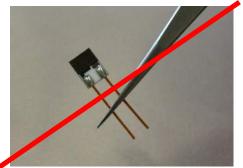
Picture 4: Sensor held with gloves

- Do not touch the active area of the sensor.
- Do not use metal tweezers to handle the sensors.
- Never handle the sensor by hand without gloves.

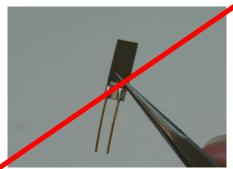
Pictures 5-8 are examples for forbidden handlings.



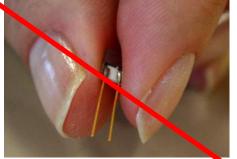
Picture 5: Sensor picked on the active area



Picture 6: Sensor picked on wires with metal tweezers



Picture 7: Sensor picked on the active area with metal tweezers



Picture 8: Sensor held with fingers with ut gloves on the active area







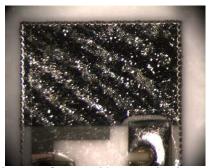
K5-W Capacitive Humidity Sensor Handling guidelines







Do not touch or scratch the active area of the sensors. Scratches and contaminations can degrade the sensor characteristic (see bad samples in pictures 9 and 10 below).



Picture 9: Sensor with contaminations



Picture 10: Sensor with a scratch

- Avoid mechanical stress to the sensors, e.g. bending or touching with sharp objects.
- Hold the sensors with plastic tweezers on the side edges only.

Soldering of the sensor

- The maximum temperature of the soldering iron of 320°C may not be exceeded. Maximum heat apply with the iron must be below 10 seconds at the very end of the connecting wires.
- The calibration of the sensors has to been done 5 days after soldering at earliest. This time is needed to provide a relaxation after the heat induces during the soldering process.
- Avoid soldering flux residues, caused by the soldering process, or any other contaminations inside the
 active area of the sensor.
- Soldering flux residues on the outside of the sensor's active area are not critical.
- If the sensor is mounted with glue we recommend baking the sensor at 80 °C for 1 hour after the gluing process.

Cleaning of the sensor

- Any residues can be easily removed with isopropanol at room temperature. Apply of low ultrasonic
 energy might improve the cleaning process. The sensor has to be dried after the cleaning process.
- The sensor cannot be cleaned mechanically with cotton swabs for instance.
- It is possible to clean the sensor with oil free and filtered clean air, e.g. for removing dust particles.



